CRMSGH1505A

N-Channel 150V, $4.4m\Omega$ Typ. Power MOSFET

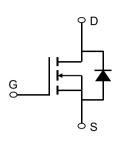
Description

Features

• 150V, 150A

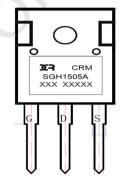
 $R_{DS(ON)}$ Typ = 4.4m Ω @ V_{GS} = 10V

- Advanced Split Gate Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!





s p c



Version: 1.0

Marking and Pin Assignment

Application

- Load Switch
- PWM Application
- Power Management

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE(pcs)	Inner Box(pcs)	Per Carton (pcs)
CRMSGH1505A	CRMSGH1505A	TO-247-3L	TUBE	25	1000	2000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		150	V
V_{GS}	Gate-to-Source Voltage		±20	V
I _D	Continuous Drain Current	$T_C = 25^{\circ}C$	150	Α
	Continuous Diain Current	T _C = 100°C	90	Α
I _{DM}	Pulsed Drain Current (1)		600	А
E _{AS}	Single Pulsed Avalanche Energy (2)		870	mJ
P_{D}	Power Dissipation	T _C = 25°C	312	W
$R_{ heta JC}$	Thermal Resistance, Junction to Cas	se	0.4	°C/W
T _J , T _{STG}	Junction & Storage Temperature Rai	nge	-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 150V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6)
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.2	3	3.8	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 30A$	-	4.4	5.7	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		- /	5087	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	-	3682	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11VII 12	X - \	180	-	pF
Q_g	Total Gate Charge	(80	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 75V, I_{D} = 20A$	U -	30	-	nC
Q_{gd}	Gate Drain("Miller") Charge	v _{DS} - 73v, i _D - 20A	-	15	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	50	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 75V$	-	89	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 20A$, $R_{GEN} = 6\Omega$	-	93	-	ns
t_f	Turn-Off Fall Time		-	58	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	150	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	600	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 454 1711 40047	-	120	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 15A$, di/dt = 100A/us	-	250	-	nC

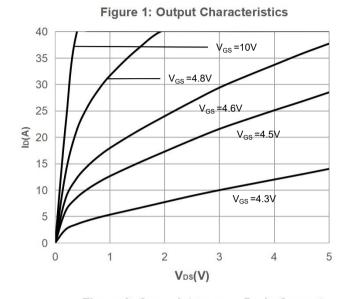
Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =50V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =59A

³ Pulse Test: Pulse Width $\!\! \leqslant \! 300 \mu s,$ Duty Cycle $\!\! \leqslant \! 0.5 \%.$

Typical Performance Characteristics



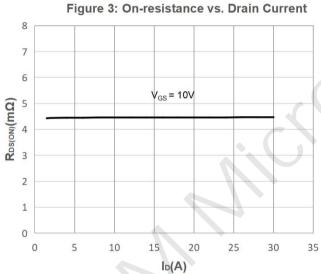


Figure 5: Gate Charge Characteristics

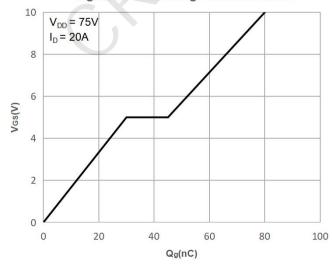


Figure 2: Typical Transfer Characteristics

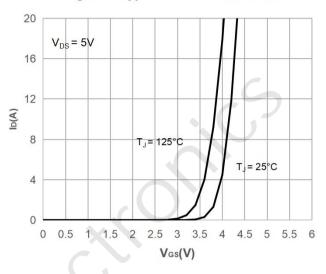


Figure 4: Body Diode Characteristics

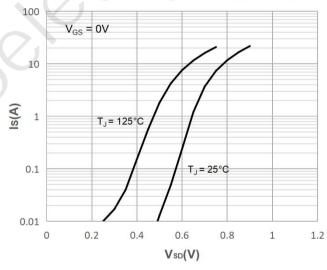
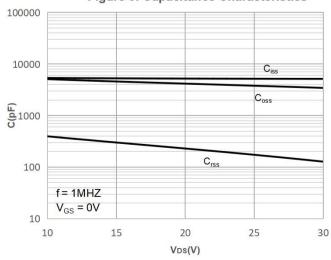


Figure 6: Capacitance Characteristics



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Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

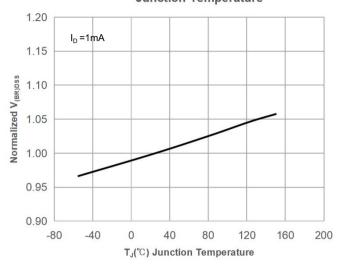


Figure 9: Maximum Safe Operating Area

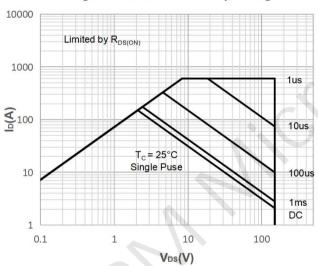


Figure 11: Normalized Maximum Transient

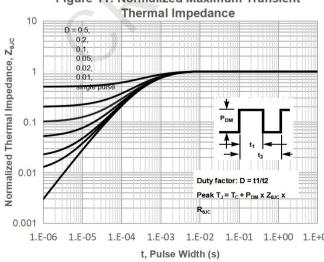


Figure 8: Normalized on Resistance vs. Junction Temperature

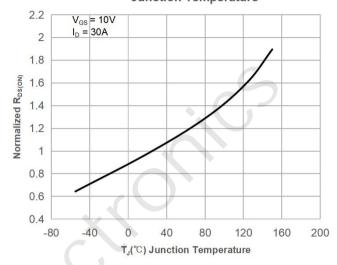


Figure 10: Maximum Continuous Drian
Current vs. Case Temperature

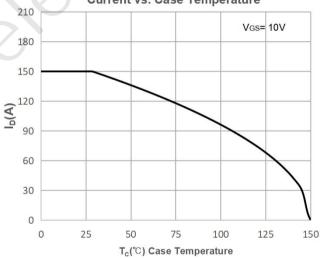
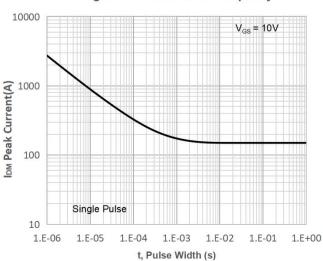


Figure 12: Peak Current Capacity



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Test Circuit

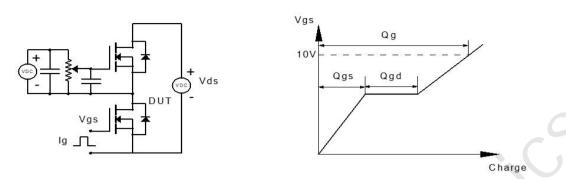


Figure 1: Gate Charge Test Circuit & Waveform

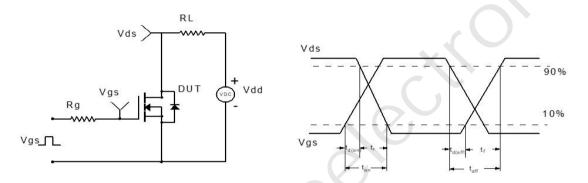


Figure 2: Resistive Switching Test Circuit & Waveform

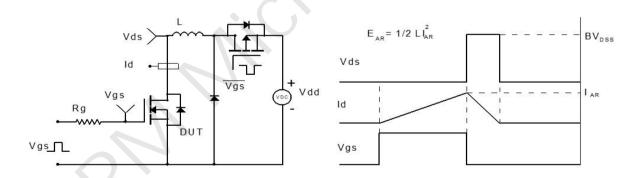


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

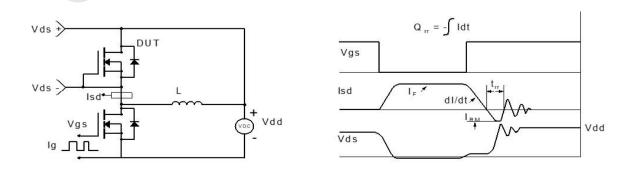
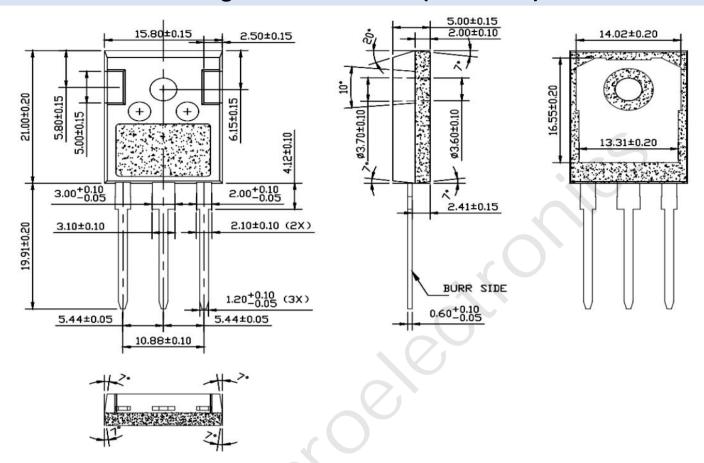


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(TO-247-3L)



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